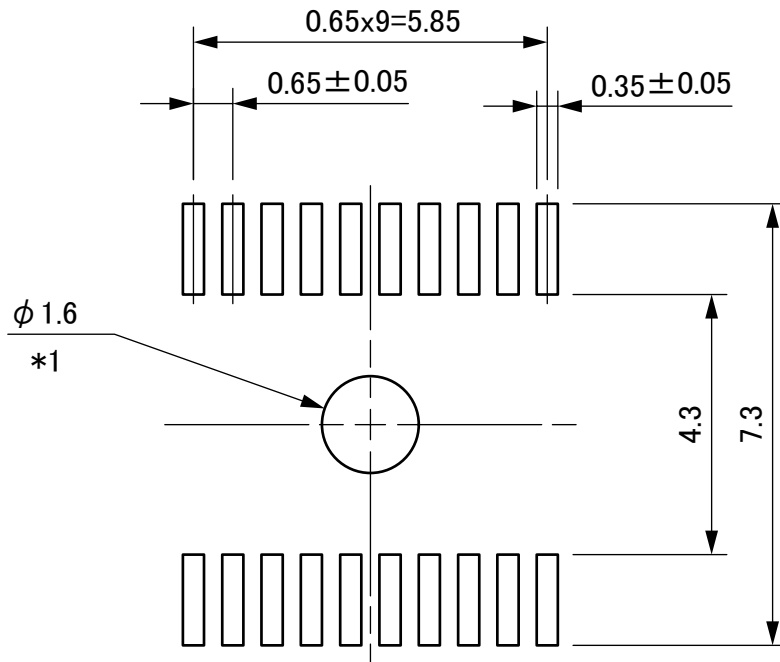


Recommended a Foot pattern of NSPACK20BG



NOTE

- *1. Non-through hole is requested when using NSPACK20BG-SL type.
- * 2. Recommended foot pattern shown on above is for NSPACK soldering.
But please refer to IC package foot pattern recommended by IC manufacturer also, when the package is soldered on the same foot pattern.
- *3. Tolerance: ± 0.1

Part No.	NSPACK20BG	
IC package	Rectangle	
Pin count	20Pin	
Lead pitch	0.65mm	
Unit : mm	Design : M.M.	
TET TOKYO ELETECH CORP.		